LB L293

SMARTLED® 0603

The innovative SMARTLED 0603 joins the successful family of TOPLED. Invested with the same high quality, its unique features are due to set new standards in product development and design, opening up new applications on a new scale.







Applications

Electronic Equipment

- White Goods

Features:

- Package: SMT package 0603, colorless diffused resin

- Chip technology: InGaN

- Typ. Radiation: 155° (horizontal), 135° (vertical)

− Color: λ_{dom} = 470 nm (• blue)

- Optical efficacy: 2.5 lm/W

- Corrosion Robustness Class: 3B

- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Ordering Information		
Туре	Luminous Intensity ¹⁾ I _F = 10 mA I _v	Ordering Code
LB L293-L2N1-25-1	14.0 35.5 mcd	Q65110A1788
LB L293-M2P1-36-1	22.4 56.0 mcd	Q65110A1791



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min. max.	-40 °C 100 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 100 °C
Junction Temperature	T _j	max.	110 °C
Forward current T _A = 25 °C	l _F	max.	20 mA
Surge Current t \leq 10 μ s; D = 0.005; T _A = 25 °C	I _{FS}	max.	200 mA
Reverse voltage ²⁾ T _A = 25 °C	V_R	max.	12 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV

Characteristics

 $I_F = 10 \text{ mA}; T_A = 25 \text{ }^{\circ}\text{C}$

Parameter	Symbol		Values
Peak Wavelength	λ_{peak}	typ.	465 nm
Dominant Wavelength 3)	$\lambda_{\sf dom}$	min.	460 nm
$I_F = 10 \text{ mA}$	dom	typ.	470 nm
		max.	480 nm
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	25 nm
Viewing angle at 50% I _v	2φ	typ.	155 °
values for 0°, 90°		typ.	135 °
Forward Voltage 4)	V _F	min.	2.75 V
$I_{\rm F} = 10 \text{ mA}$		typ.	3.10 V
		max.	3.50 V
Reverse current 2)	I _R	max.	10 μΑ
V _R = 12 V			
Temperature Coefficient of Peak Wavelength -10°C ≤ T ≤ 100°C	$TC_{\lambda peak}$	typ.	0.04 nm / K
Temperature Coefficient of Dominant Wavelength -10°C ≤ T ≤ 100°C	$TC_{\scriptscriptstyle{\lambdadom}}$	typ.	0.03 nm / K
Temperature Coefficient of Forward Voltage -10°C ≤ T ≤ 100°C	TC_{VF}	typ.	-4.5 mV / K
Real thermal resistance junction/ambient 5)6)	$R_{thJA\ real}$	max.	450 K / W
Real thermal resistance junction/solderpoint 5)	R _{thJS real}	max.	260 K / W

Group	Luminous Intensity ¹⁾ $I_F = 10 \text{ mA}$ min. I_V	Luminous Intensity. 1) I _F = 10 mA max. I _v	Luminous Flux $^{7)}$ $I_F = 10 \text{ mA}$ $typ.$ Φ_V
L2	14.0 mcd	18.0 mcd	64.0 mlm
M1	18.0 mcd	22.4 mcd	80.8 mlm
M2	22.4 mcd	28.0 mcd	100.8 mlm
N1	28.0 mcd	35.5 mcd	127.0 mlm
N2	35.5 mcd	45.0 mcd	161.0 mlm
P1	45.0 mcd	56.0 mcd	202.0 mlm

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ I _F = 10 mA min.	Forward Voltage ⁴⁾ I _F = 10 mA max.	
	V_{F}	V_{F}	
3B	2.75 V	2.90 V	
4A	2.90 V	3.05 V	
4B	3.05 V	3.20 V	
5A	3.20 V	3.35 V	
5B	3.35 V	3.50 V	

Wavelength Groups

Group	Dominant Wavelength 3)	Dominant Wavelength 3)	
	$I_F = 10 \text{ mA}$	$I_F = 10 \text{ mA}$	
	min.	max.	
	$\lambda_{\sf dom}$	$\lambda_{\sf dom}$	
2	460 nm	464 nm	
3	464 nm	468 nm	
4	468 nm	472 nm	
5	472 nm	476 nm	
6	476 nm	480 nm	

Discontinued

Group Name on Label

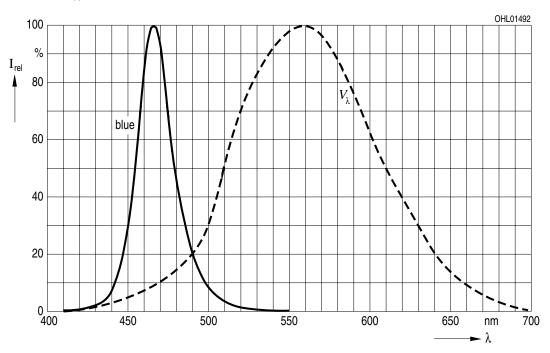
Example: L2-2-3B

Brightness	Wavelength	Forward Voltage
L2	2	3B



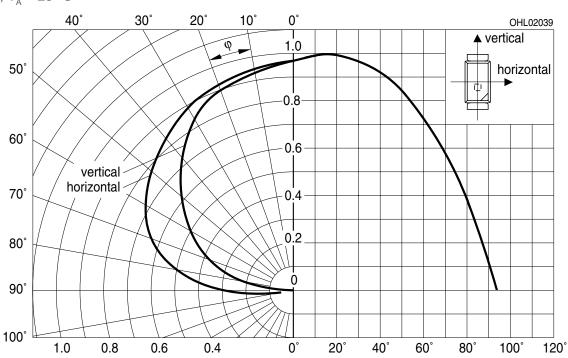
Relative Spectral Emission 7)

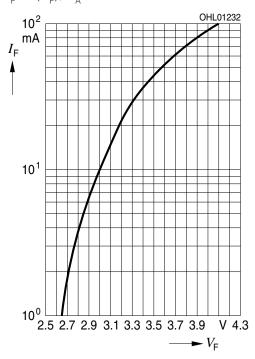
 $I_{rel} = f(\lambda); I_F = 10 \text{ mA}; T_A = 25 ^{\circ}\text{C}$



Radiation Characteristics 7)

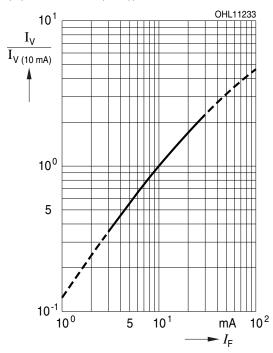
 $I_{rel} = f(\phi); T_A = 25 °C$





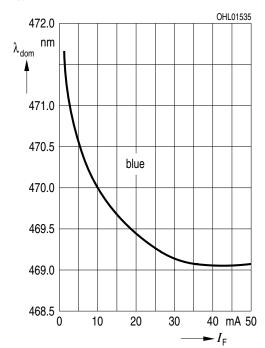
Relative Luminous Intensity 7), 8)

 $I_{v}/I_{v}(10 \text{ mA}) = f(I_{F}); T_{A} = 25 \text{ }^{\circ}\text{C}$



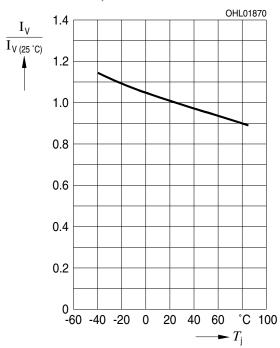
Dominant Wavelength 7)

 $\lambda_{dom} = f(I_F); T_A = 25 \text{ }^{\circ}\text{C}$



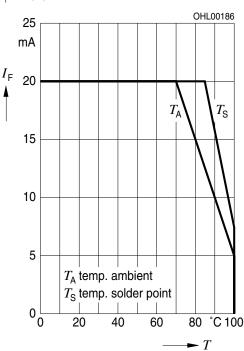
Relative Luminous Intensity 7)

 $I_{v}/I_{v}(25 \text{ °C}) = f(T_{j}); I_{F} = 10 \text{ mA}$



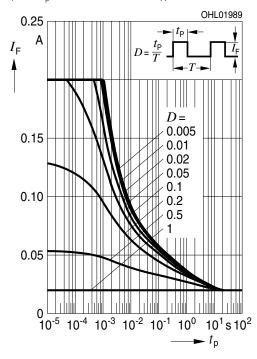
Max. Permissible Forward Current

 $I_F = f(T)$



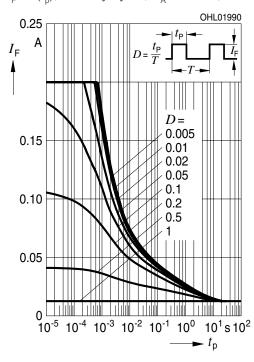
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; D: Duty cycle; $T_A = 25 \, ^{\circ}C$

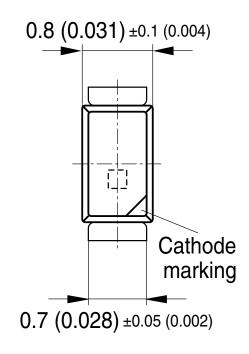


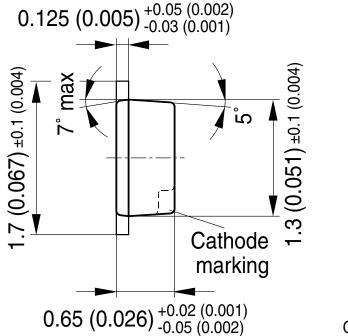
Permissible Pulse Handling Capability

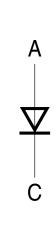
 $I_F = f(t_p)$; D: Duty cycle; $T_A = 85 \text{ °C}$;



Dimensional Drawing 9)







GPLY7057

Further Information

Approximate Weight: 1.6 mg

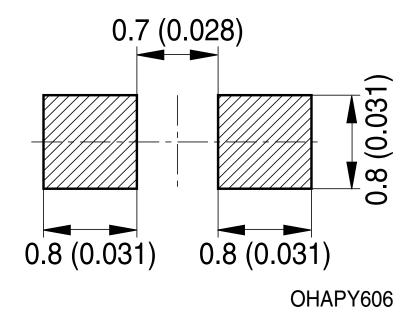
Package marking: Cathode

Corrosion test: Class: 3B

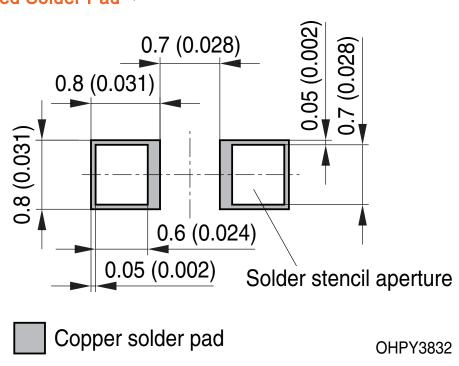
Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC

60068-2-43)

Recommended Solder Pad 9)



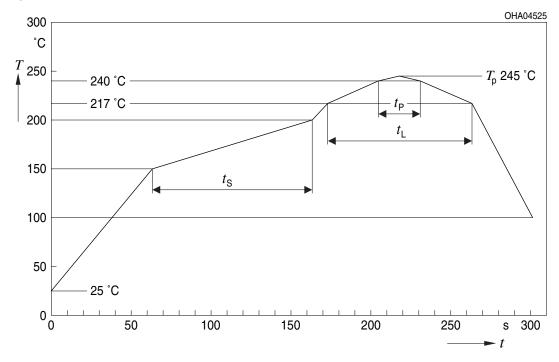
Recommended Solder Pad 9)



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



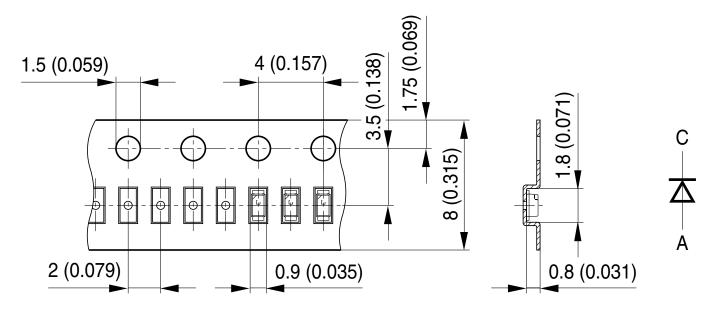
Profile Feature	Symbol	Pb	-Free (SnAgCu) Ass	sembly	Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)			2	3	K/s
25 °C to 150 °C					
Time t _s	t_s	60	100	120	S
T_{Smin} to T_{Smax}					
Ramp-up rate to peak*)			2	3	K/s
T_{Smax} to T_{P}					
Liquidus temperature	T_{L}		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S
Peak temperature	T _P		245	260	°C
Time within 5 °C of the specified peak	t _P	10	20	30	S
temperature T _P - 5 K					
Ramp-down rate*			3	6	K/s
T _P to 100 °C					
Time				480	S
25 °C to T _P					

All temperatures refer to the center of the package, measured on the top of the component



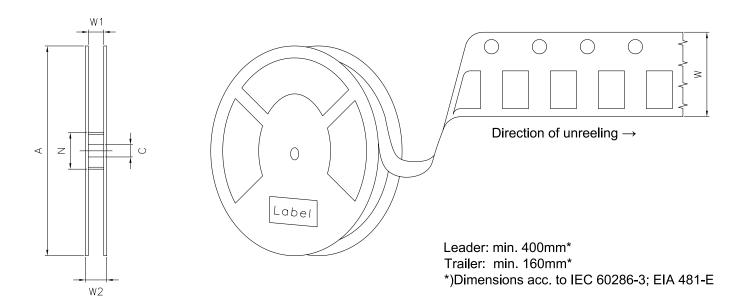
^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping 9)



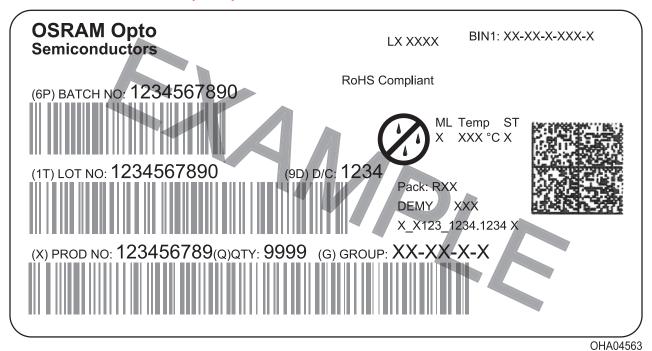
OHAY1491

Tape and Reel 10)

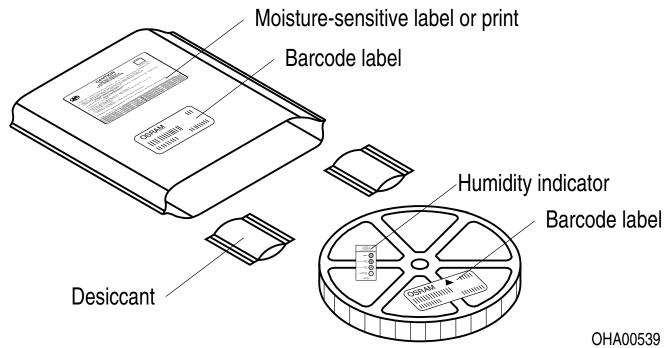


Reel Dimensions

Α	W	N_{\min}	W_1	$W_{2 \text{max}}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	5000

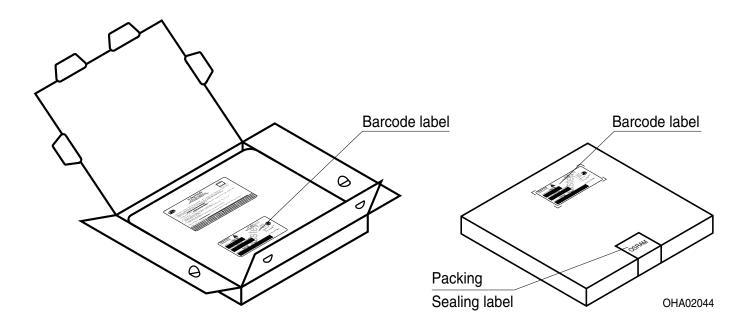


Dry Packing Process and Materials 9)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Schematic Transportation Box 9)



Dimensions of Transportation Box

Width	Length	Height	
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm	

Discontinued

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disconfinued

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



Disconfinied

Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 8 % and an expanded uncertainty of ± 11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of k = 3).
- Thermal Resistance: Rth max is based on statistic values (6σ) .
- ⁶⁾ Thermal Resistance: RthJA results from mounting on PC board FR 4 (pad size ≥ 5 mm² per pad)
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁸⁾ Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision	n History	
Version	Date	Change
1.2	2019-07-15	Discontinued



Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product Leibnizstraße 4, D-93055 Regensburg www.osram-os.com © All Rights Reserved.

此产品符合欧盟 RoHS 指令的要求;

按照中国的相关法规和标准,不含有毒有害物质或元素。

